RC4136, RM4136, RV4136 QUAD GENERAL-PURPOSE OPERATIONAL AMPLIFIERS

The RM4136 and RV4136 are obsolete and are no longer supplied.

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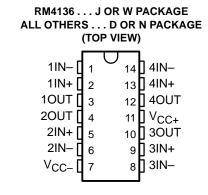
- Continuous Short-Circuit Protection
- Wide Common-Mode and Differential Voltage Ranges
- No Frequency Compensation Required
- Low Power Consumption
- No Latch-Up
- Unity-Gain Bandwidth . . . 3 MHz Typ
- Gain and Phase Match Between Amplifiers
- Designed To Be Interchangeable With Raytheon RC4136, RM4136, and RV4136
- Low Noise . . . 8 nV√Hz Typ at 1 kHz

description

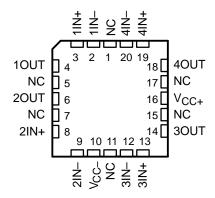
The RC4136, RM4136, and RV4136 are quad general-purpose operational amplifiers, with each amplifier electrically similar to the μ A741, except that offset null capability is not provided.

The high common-mode input voltage range and the absence of latch-up make these amplifiers ideal for voltage-follower applications. The devices are short-circuit protected and the internal frequency compensation ensures stability without external components.

The RC4136 is characterized for operation from 0°C to 70°C, the RM4136 is characterized for operation over the full military temperature range of -55°C to 125°C, and the RV4136 is characterized for operation from -40°C to 85°C.

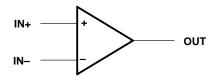


RM4136 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

symbol (each amplifier)



AVAILABLE OPTIONS

	VIOMAX	PACKAGE								
TA	AT 25°C	SMALL OUTLINE CHIP CARRIEF (FK)		CERAMIC DIP (J)	PLASTIC DIP (N)	FLAT (W)				
0°C to 70°C	6 mV	RC4136D	_		RC4136N	_				
–40°C to 85°C	6 mV	RV4136D	_	_	RV4136N	_				
–55°C to 125°C	4 mV	_	RM4136FK	RM4136J	_	RM4136W				

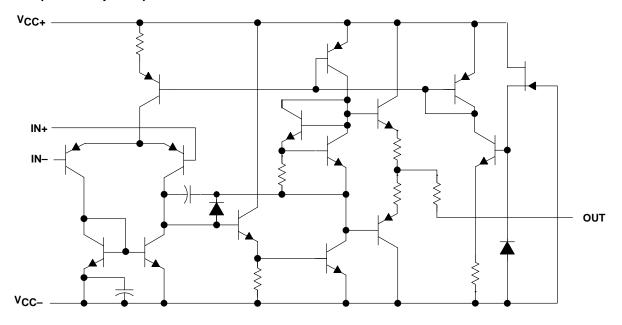
The D packages are available taped and reeled. Add the suffix R to the device type (e.g., RC4136DR).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



schematic (each amplifier)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage (see Note 1): V _{CC+} , RC4136 and RV4136	18 V
V _{CC+} , RM4136	22 V
V _{CC} _ RC4136 and RV4136	
V _{CC} _ RM4136	
Differential input voltage, V _{ID} (see Note 2)	±30 V
Input voltage, V _I (any input) (see Notes 1 and 3)	
Duration of output short circuit to ground, one amplifier at a time (see Note 4)	Unlimited
Continuous total dissination	O District Defeat Table
Continuous total dissipation	See Dissipation Rating Table
Package thermal impedance, θ _{JA} (see Note 5): D package	
Package thermal impedance, θ_{JA} (see Note 5): D package	
Package thermal impedance, θ_{JA} (see Note 5): D package	86°C/W 80°C/W
Package thermal impedance, θ_{JA} (see Note 5): D package N package	
Package thermal impedance, θ_{JA} (see Note 5): D package	
Package thermal impedance, θ_{JA} (see Note 5): D package	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, unless otherwise noted, are with respect to the midpoint between V_{CC+} and V_{CC-}.

- 2. Differential voltages are at IN+ with respect to IN-.
- 3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 V, whichever is less.
- 4. Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.
- 5. The package thermal impedance is calculated in accordance with JESD 51-7.

DISSIPATION RATING TABLE

PACKAGE	T _A ≤ 25°C POWER RATING	DERATING FACTOR	DERATE ABOVE T _A	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING	T _A = 125°C POWER RATING
FK	800 mW	11.0 mW/°C	77°C	800 mW	715 mW	275 mW
J	800 mW	11.0 mW/°C	77°C	800 mW	715 mW	275 mW
W	800 mW	8.0 mW/°C	50°C	640 mW	520 mW	200 mW



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recommended operating conditions

		MIN	MAX	UNIT
V _{CC+}	Supply voltage	5	15	V
VCC-	Supply voltage	-5	-15	V

electrical characteristics at specified free-air temperature, $V_{CC+} = 15 \text{ V}$, $V_{CC-} = -15 \text{ V}$

	DAD AMETED	TEST CONDITIONS†		F	RC4136	6	RM4136			RV4136			UNIT
ľ	PARAMETER			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNII
	Input offset		25°C		0.5	6		0.5	4		0.5	6	
V_{IL}	voltage	V _O = 0	Full range			7.5			6			7.5	mV
			25°C		5	200		5	150		5	200	
I _{IO}	Input offset	V _O = 0	Full			200			130			200	nA
-10	current	1.0 °	range			300			500			500	""
			25°C		140	500		140	400		140	500	
l _{IB}	Input bias current	VO = 0	Full range			800			1500			1500	nA
Vi	Input voltage range		25°C	±12	±14		±12	±14		±12	±14		V
	Massinas na anti-	$R_L = 10 \text{ k}\Omega$	25°C	±12	±14		±12	±14		±12	±14		
Vом	Maximum peak output voltage	$R_L = 2 k\Omega$	25°C	±10	±13		±10	±13		±10	±13		V
VOIVI	swing	$R_L \ge 2 k\Omega$	Full range	±10			±10			±10			
	Large-signal	Vo - +10 V	25°C	20	300		50	350		20	300		V/mV
AVD	differential voltage amplification	$V_O = \pm 10 \text{ V},$ $R_L \ge 2 \text{ k}\Omega$	Full range	15			25			15			
B ₁	Unity-gain bandwidth		25°C		3			3.5			3		MHz
rį	Input resistance		25°C	0.3*	5		0.3*	5		0.3*	5		MΩ
CMRR	Common-mode rejection ratio	$V_O = 0$, $R_S = 50 \Omega$	25°C	70	90		70	90		70	90		dB
kSVS	Supply-voltage sensitivity (ΔV _{IO} /ΔV _{CC})	$V_{CC} = \pm 9 \text{ V to } \pm 15 \text{ V},$ $V_{O} = 0$	25°C		30	150		30	150		30	150	μV/V
Vn	Equivalent input noise voltage (closed loop)	AVD = 100, BW = 1 Hz, f = 1 kHz, RS = 100 \Omega	25°C		8			8			8		nV√Hz
			25°C		5	11.3		5	11.3		5	11.3	
ICC	Supply current (all four amplifiers)	V _O = 0, No load	MIN T _A		6	13.7		6	13.3		6	13.7	mA
	(an roar ampiniors)		MAX T _A		4.5	10		4.5	10		4.5	10	
	Total power		25°C		150	340		150	340		150	340	
P_{D}	dissipation	$V_O = 0$, No load	MIN T _A		180	400		180	400		180	400	mW
	(all four amplifiers)		MAX T _A		135	300		135	300		135	300	
	Crosstalk attenuation (VO1/VO2)	$A_{VD} = 100,$ f = 10 kHz, $R_{S} = 1 \text{ k}\Omega$	25°C		105			105			105		dB

^{*} This parameter is not production tested.

[†] All characteristics are measured under open-loop conditions with zero common-mode input voltage, unless otherwise specified. Full range is 0°C to 70°C for RC4136, –55°C to 125°C for RM4136, and –40°C to 85°C for RV4136. Minimum T_A is 0°C for RC4136, –55°C for RM4136, and –40°C for RV4136. Maximum T_A is 70°C for RC4136, 125°C for RM4136, and 85°C for RV4136.



RC4136, RM4136, RV4136 QUAD GENERAL-PURPOSE OPERATIONAL AMPLIFIERS

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The RM4136 and RV4136 are obsolete and are no longer supplied.

operating characteristics, V_{CC+} = 15 V, V_{CC-} = -15 V, T_A = 25°C

	PARAMETER	TE	TYP	UNIT	
t _r	Rise time	$V_I = 20 \text{ mV},$	$C_L = 100 \text{ pF}, R_L = 2 \text{ k}\Omega$	0.13	μs
	Overshoot factor	$V_I = 20 \text{ mV},$	$C_L = 100 \text{ pF}, R_L = 2 \text{ k}\Omega$	5	%
SR	Slew rate at unity gain	V _I = 10 V,	$C_L = 100 \text{ pF}, R_L = 2 \text{ k}\Omega$	1.7	V/µs



PACKAGE OPTION ADDENDUM

9-Feb-2007

PACKAGING INFORMATION

www ti com

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins F	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
RC4136D	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
RC4136DR	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
RC4136N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
RC4136NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

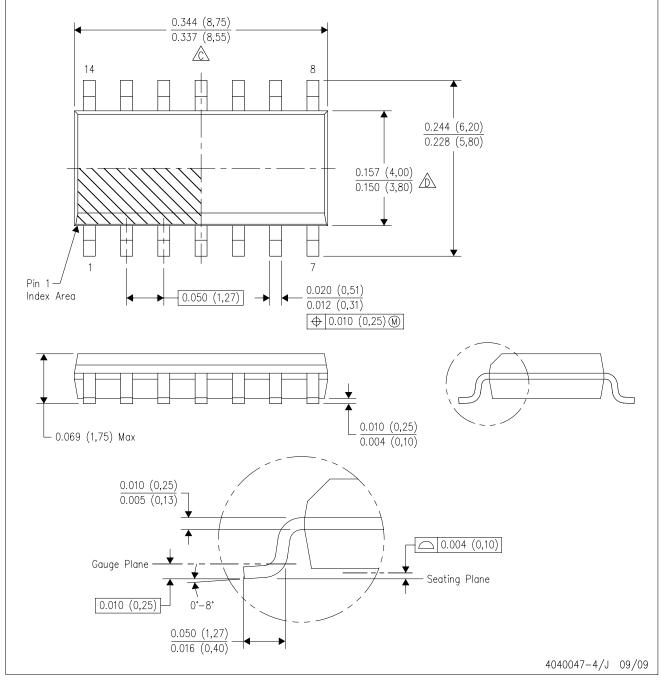
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

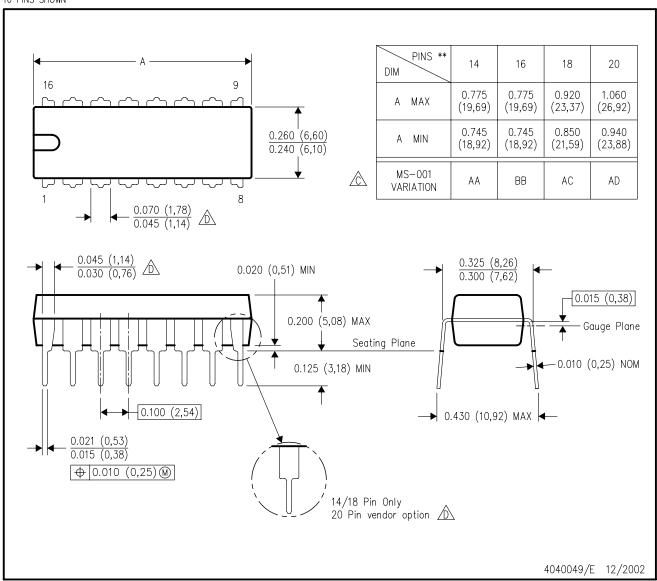
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AB.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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